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Electronic Version v1.1

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Title of	
Invention	

PATTERNED STRAINED SEMICONDUCTOR SUBSTRATE AND DEVICE

Application Number:

Date:

First Named Applicant:

Kangguo Cheng

Confirmation Number:
Attorney Docket Number:

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Documents being submitted:	Files
us-request	FIS92004150US1E-Filing-usrequ.xml
	us-request.dtd
	us-request.xsl
us-assignment	FIS92004150US1E-Filing-usassn.xml
	us-assignment.xsl
	us-assignment.dtd
	FIS920040150US1Assign1.tif
	FIS920040150US1Assign2.tif
us-fee-sheet	FIS92004150US1E-Filing-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	FIS920040150US1Dec1.tif
us-declaration	FIS920040150US1Dec2.tif
application-body	FIS920040150US1-trans.xml
	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-qname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
	mmlextra.ent
	mmlalias.ent
	soextblx.dtd
	FIS920040150US1Drawing1.tif
	FIS920040150US1Drawing2.tif
	FIS920040150US1Drawing3.tif
	FIS920040150US1Drawing4.tif
	FIS920040150US1Drawing5.tif
	FIS920040150US1Drawing6.tif
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FIS920040150US1Drawing9.tif FIS920040150US1Drawing10.tif FIS920040150US1Drawing11.tif FIS920040150US1Drawing12.tif FIS920040150US1Drawing13.tif FIS920040150US1Drawing14.tif FIS920040150US1Drawing15.tif FIS920040150US1Drawing16.tif FIS920040150US1Drawing17.tif FIS920040150US1Drawing18.tif FIS920040150US1Drawing19.tif FIS920040150US1Drawing20.tif FIS920040150US1Drawing21.tif FIS920040150US1Drawing22.tif FIS920040150US1Drawing23.tif FIS920040150US1Drawing24.tif FIS920040150US1Drawing25.tif FIS920040150US1Drawing26.tif FIS920040150US1Drawing27.tif FIS920040150US1Drawing28.tif FIS920040150US1Drawing29.tif FIS920040150US1Drawing30.tif FIS920040150US1Drawing31.tif FIS920040150US1Drawing32.tif FIS920040150US1Drawing33.tif FIS920040150US1Drawing34.tif FIS920040150US1Drawing35.tif FIS920040150US1Drawing36.tif FIS920040150US1Drawing37.tif FIS920040150US1Drawing38.tif FIS920040150US1Drawing39.tif

Comments

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